



# RCP6V4x

## Transient Voltage Suppressor

### Features

- ANODE-Common Structure (Dual TVS)
- Suitable to small packages(SOT-363) Chip Size=0.40mmsq
- High ESD protection level  
IEC61000-4-2(ESD) +/-30kV(Air) +/-30kV(Contact)

### Applications

It is intended for use in voltage and ESD sensitive equipment such as:

- Computers
- Printers
- Communication systems

Item	Characteristics
Wafer Size	5inch
Chip Size	400*400um

### Maximum Ratings (Ta=25degC)

Symbol	Parameter	Value	Units
Ppk	Peak Power Dissipation @=8/20us (*1)	80.5	W
Ipp	Maximum Peak Pulse Current @=8/20us (*1)	7.0	A
Pd	Power Dissipation	350	mW
Tj	Maximum Junction Temperature (*1)	150	degC
Tstg	Storage Temperature Range	-55 to+150	degC
Vpp	Electrostatic Discharge IEC61000-4-2 Air Discharge (*1) IEC61000-4-2 Contact Discharge (*1)	$\pm 30$ $\pm 30$	kV kV

(\*1) Rating value for reference on a SOT-23 package configuration (front: Au wire 35um, back: Au eutectic), mounted on PCB of 1.5cm by 2.5cm.

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## Electrical Characteristics (Ta=25degC)

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Parameter	Symbol	Min	Typ.	Max	Unit	Condition
Breakdown Voltage	V <sub>BR</sub>	6.4	6.8	7.2	V	I <sub>R</sub> =5mA
Leakage Current	I <sub>RM</sub>	-	-	1.0	uA	V <sub>rwm</sub> =5V
Forward Voltage Drop	V <sub>F</sub>	-	-	1.25	V	I <sub>F</sub> =10mA
Typical Capacitance	C	-	40	-	pF	0V , 1MHz
Dynamic Impedance	Z <sub>ZT</sub>	-	-	30	ohm	I <sub>z</sub> =5mA
Knee Dynamic Impedance	Z <sub>ZK</sub>	-	-	300	ohm	I <sub>z</sub> =0.5mA
Clamping Voltage	V <sub>c</sub>			11.5	V	I <sub>pp</sub> =7.0A *1

\*1 Package=SOT-23 (front: Au wire 35um, back: Au eutectic),